# MOSFET – Power, Single, N-Channel, SO-8 FL 30 V, 93 A

#### Features

- Low R<sub>DS(on)</sub> to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- Optimized Gate Charge to Minimize Switching Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

# Applications

• CPU Power Delivery, DC-DC Converters

### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise stated)

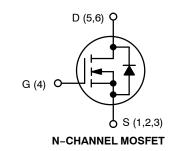
			Symbol	·	1 line it
	Parameter			Value	Unit
Drain-to-Source Voltage			V <sub>DSS</sub>	30	V
Gate-to-Source Volt	ltage		V <sub>GS</sub>	±20	V
Continuous Drain Current R <sub>θJA</sub>		$T_A = 25^{\circ}C$	۱ <sub>D</sub>	21.8	А
(Note 1)		$T_A = 100^{\circ}C$	1	13.8	
Power Dissipation $R_{\theta JA}$ (Note 1)		$T_A = 25^{\circ}C$	PD	2.63	W
Continuous Drain Current R <sub>θJA</sub> ≤	1	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	40	А
10 s (Note 1)		T <sub>A</sub> = 100°C		25	
Power Dissipation		$T_A = 25^{\circ}C$	P <sub>D</sub>	8.7	W
R <sub>θJA</sub> ≤ 10 s (Note 1)	Steady State				
Continuous Drain Current R <sub>0.IA</sub>	Oluic	$T_A = 25^{\circ}C$	۱ <sub>D</sub>	13	A
(Note 2)		T <sub>A</sub> = 100°C		8.2	
Power Dissipation $R_{\theta JA}$ (Note 2)		$T_A = 25^{\circ}C$	PD	0.93	W
Continuous Drain Current $R_{\theta JC}$	1	$T_{C} = 25^{\circ}C$	۱ <sub>D</sub>	93	А
(Note 1)		T <sub>C</sub> = 85°C		59	
Power Dissipation $R_{\theta JC}$ (Note 1)		T <sub>C</sub> = 25°C	PD	48	W
Pulsed Drain Current	T <sub>A</sub> = 25°	T <sub>A</sub> = 25°C, t <sub>p</sub> = 10 μs		275	A
Current Limited by Package $T_A = 25^{\circ}C$			I <sub>Dmax</sub>	100	А
Operating Junction a Temperature	Operating Junction and Storage Temperature		Tj, T <sub>STG</sub>	–55 to +150	°C
Source Current (Bod	y Diode)		ا <sub>S</sub>	44	А
Drain to Source DV/I	Drain to Source DV/DT			6	V/ns

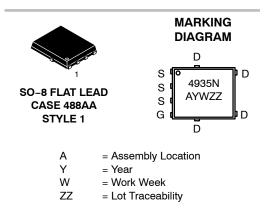


# **ON Semiconductor®**

## http://onsemi.com

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> MAX	I <sub>D</sub> MAX
30 V	$3.2~\mathrm{m}\Omega$ @ 10 V	00.4
30 V	4.2 mΩ @ 4.5 V	93 A





#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NTMFS4935NT1G	SO-8 FL	1500 /
NTMFS4935NCT1G	(Pb-Free)	Tape & Reel
NTMFS4935NT3G	SO-8 FL	5000 /
NTMFS4935NCT3G	(Pb-Free)	Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise stated)

Parameter	Symbol	Value	Unit
Single Pulse Drain–to–Source Avalanche Energy T <sub>J</sub> = 25°C, V <sub>DD</sub> = 24 V, V <sub>GS</sub> = 10 V, I <sub>L</sub> = 47 A <sub>pk</sub> , L = 0.1 mH, R <sub>G</sub> = 25 $\Omega$	E <sub>AS</sub>	110	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)	TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.
1. Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
2. Surface-mounted on FR4 board using the minimum recommended pad size.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Drain)	$R_{ extsf{ heta}JC}$	2.6	
Junction-to-Ambient - Steady State (Note 3)	$R_{\theta JA}$	47.5	°C/W
Junction-to-Ambient - Steady State (Note 4)	$R_{\theta JA}$	134.8	°C/W
Junction-to-Ambient – (t $\leq$ 10 s) (Note 3)	$R_{\thetaJA}$	14.4	

Surface-mounted on FR4 board using 1 sq-in pad, 1 oz Cu.
 Surface-mounted on FR4 board using the minimum recommended pad size.

#### ELECTRICAL CHARACTERISTICS (T<sub>J</sub> = 25°C unless otherwise specified)

Parameter	Symbol	Test Cond	lition	Min	Тур	Max	Unit
OFF CHARACTERISTICS	-			-	-	-	-
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{GS}$ = 0 V, $I_D$ = 250 $\mu$ A		30			V
Drain-to-Source Breakdown Voltage (transient)	V <sub>(BR)DSSt</sub>	V <sub>GS</sub> = 0 V, I <sub>D(ava</sub> T <sub>case</sub> = 25°C, t <sub>trans</sub>	<sub>al)</sub> = 19.5 A, <sub>sient</sub> = 100 ns	34			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> / T <sub>J</sub>				15		mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS} = 0 V,$	$T_J = 25^{\circ}C$			1.0	
		V <sub>DS</sub> = 24 V	$T_J = 125^{\circ}C$			10	μA
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS}$	<sub>S</sub> = ±20 V			±100	nA
ON CHARACTERISTICS (Note 5)							
Gate Threshold Voltage	V <sub>GS(TH)</sub>	$V_{GS}$ = $V_{DS}$ , $I_D$ = 250 $\mu$ A		1.2	1.63	2.2	V
Negative Threshold Temperature Coefficient	V <sub>GS(TH)</sub> /T <sub>J</sub>				4.0		mV/°C
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 30 A		2.7	3.2	
			I <sub>D</sub> = 15 A		2.7		
		V <sub>GS</sub> = 4.5 V	I <sub>D</sub> = 30 A		3.7	4.2	mΩ
			I <sub>D</sub> = 15 A		3.7		
Forward Transconductance	9 <sub>FS</sub>	V <sub>DS</sub> = 1.5 V, I <sub>D</sub> = 15 A			32		S
CHARGES, CAPACITANCES & GATE RESIS	TANCE						-
Input Capacitance	C <sub>ISS</sub>				3579	4850	
Output Capacitance	C <sub>OSS</sub>	V <sub>GS</sub> = 0 V, f = 1 MHz, V <sub>DS</sub> = 15 V			1264	1710	pF
Reverse Transfer Capacitance	C <sub>RSS</sub>				39	59	
Capacitance Ratio	C <sub>RSS</sub> / C <sub>ISS</sub>	$V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = 15 V			0.011	0.022	
Total Gate Charge	Q <sub>G(TOT)</sub>				22		
Threshold Gate Charge	Q <sub>G(TH)</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V; I <sub>D</sub> = 30 A			5.6		
Gate-to-Source Charge	Q <sub>GS</sub>				10.2		nC
Gate-to-Drain Charge	Q <sub>GD</sub>				3.0		

## SWITCHING CHARACTERISTICS (Note 6)

Total Gate Charge

Turn-On Delay Time	t <sub>d(ON)</sub>		16.3	
Rise Time	t <sub>r</sub>	V <sub>GS</sub> = 4.5 V, V <sub>DS</sub> = 15 V,	20	
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$I_{\rm D}$ = 15 A, R <sub>G</sub> = 3.0 $\Omega$	27.5	ns
Fall Time	t <sub>f</sub>		6.6	

 $V_{GS}$  = 10 V,  $V_{DS}$  = 15 V;  $I_{D}$  = 30 A

49.4

nC

Q<sub>G(TOT)</sub>

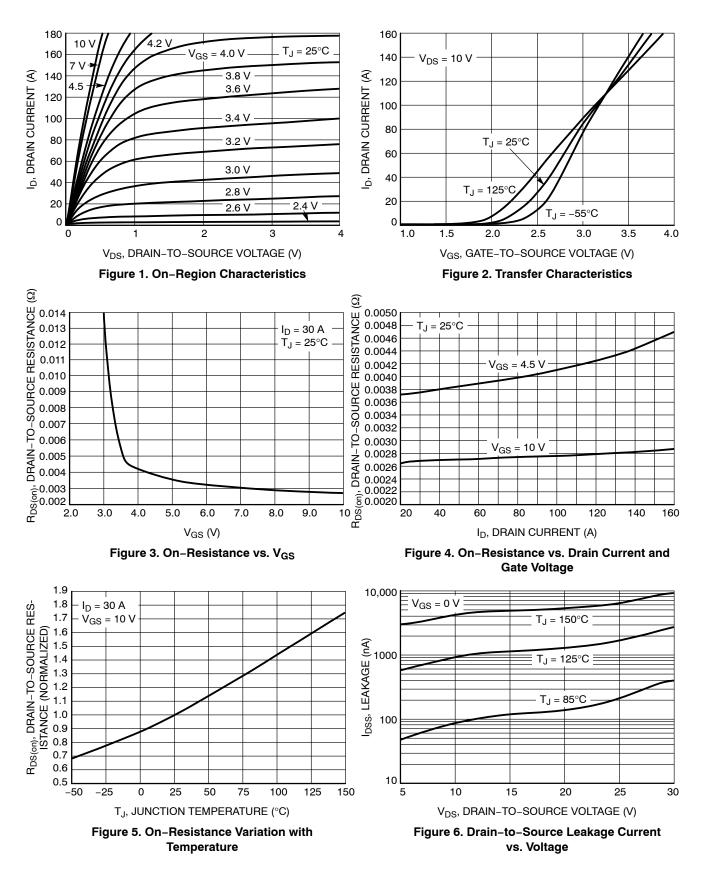
5. Pulse Test: pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%. 6. Switching characteristics are independent of operating junction temperatures.

# **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise specified)

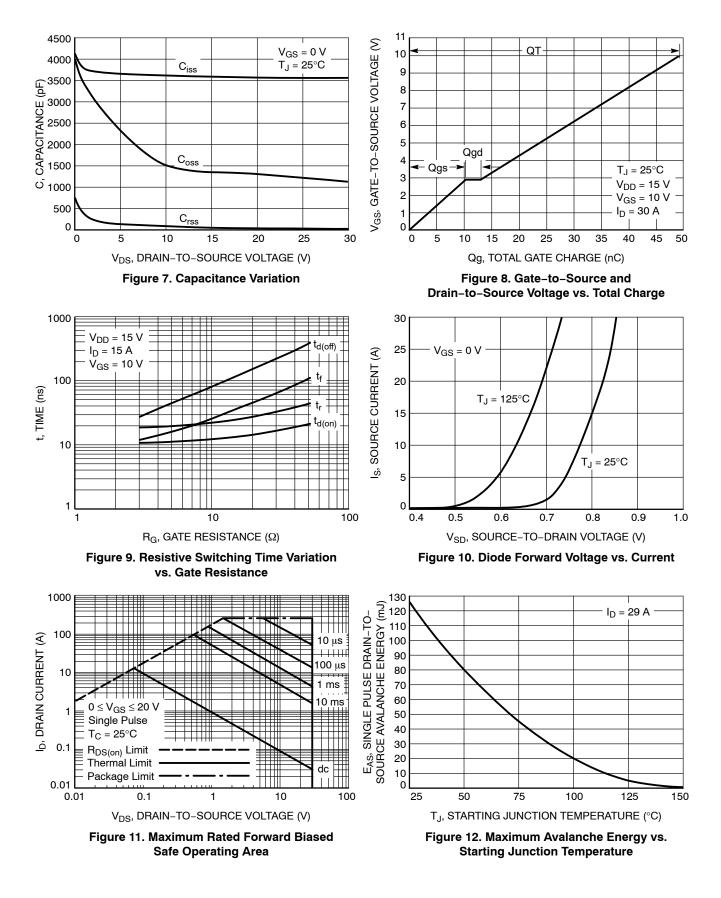
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS (N	ote 6)						
Turn-On Delay Time	t <sub>d(ON)</sub>	$V_{GS}$ = 10 V, $V_{DS}$ = 15 V, I_D = 15 A, R_G = 3.0 $\Omega$			11.2		
Rise Time	t <sub>r</sub>				18.7		
Turn-Off Delay Time	t <sub>d(OFF)</sub>	$I_{\rm D} = 15 \rm A,  R_{\rm C}$	= 3.0 Ω		28.3		ns
Fall Time	t <sub>f</sub>	1			12.1		1
DRAIN-SOURCE DIODE CHARACTI	ERISTICS						
Forward Diode Voltage	V <sub>SD</sub>	$V_{SD} \qquad V_{GS} = 0 \text{ V}, \\ I_{S} = 30 \text{ A} \qquad T_{J} = 25^{\circ}\text{C} \\ T_{J} = 125^{\circ}\text{C}$		0.85	1.1		
			T <sub>J</sub> = 125°C		0.72		V
Reverse Recovery Time	t <sub>RR</sub>				44.4		
Charge Time	t <sub>a</sub>	V <sub>GS</sub> = 0 V, dIS/d	: = 100 A/μs,		21.6		ns
Discharge Time	t <sub>b</sub>	$I_{\rm S} = 30  {\rm A}$			22.8		
Reverse Recovery Charge	Q <sub>RR</sub>				45		nC
PACKAGE PARASITIC VALUES				-	-		
Source Inductance	L <sub>S</sub>	− T <sub>A</sub> = 25°C			0.65		nH
Drain Inductance	L <sub>D</sub>				0.005		nH
Gate Inductance	L <sub>G</sub>				1.84		nH
Gate Resistance	R <sub>G</sub>				1.1	1.4	Ω

5. Pulse Test: pulse width  $\leq$  300 µs, duty cycle  $\leq$  2%. 6. Switching characteristics are independent of operating junction temperatures.

# **TYPICAL CHARACTERISTICS**



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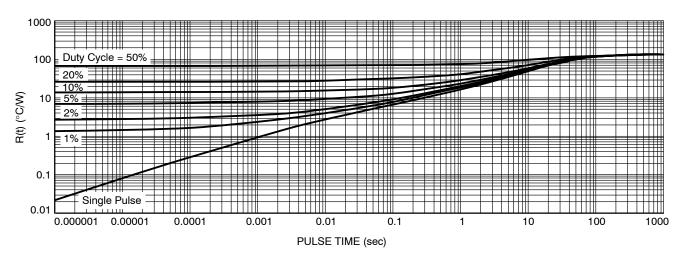
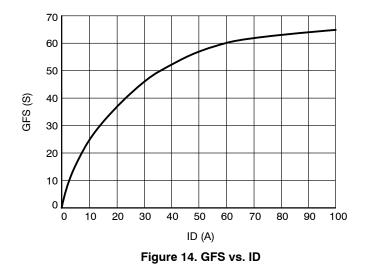


Figure 13. Thermal Response



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